VSMY2853SLX01

Vishay Semiconductors

High Speed Infrared Emitting Diodes, 850 nm, Surface Emitter Technology



www.vishay.com

DESCRIPTION

As part of the SurfLightTM portfolio, the VSMY2853 series are infrared, 850 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- Automotive sensors
- Miniature light barrier
- Photointerrupters
- · Optical switch
- Emitter source for proximity sensors
- IR illumination

FEATURES

- Package type: surface-mount
- · Package form: side view
- Dimensions (L x W x H in mm): 2.3 x 2.55 x 2.3
- AEC-Q101 gualified
- Peak wavelength: $\lambda_p = 850 \text{ nm}$
- High reliability
- · High radiant power
- Very high radiant intensity
- Angle of half intensity: $\varphi = \pm 28^{\circ}$
- · Suitable for high pulse current operation
- · Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2xx3SLX01 and VEMR2xx3SLX01 series
- · Floor life: 4 weeks, MSL 2a, according to J-STD-020
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

PRODUCT SUMMARY					
COMPONENT	l _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)	
VSMY2853SLX01	50	± 28	850	10	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY2853SLX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Side view	

Note

MOQ: minimum order quantity

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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		VR	5	V
Forward current		I _F	100	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA
Surge forward current	t _p = 100 μs	I _{FSM}	1	A
Power dissipation		Pv	190	mW
Junction temperature		Тj	100	°C
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	According to Fig. 7, J-STD-020	T _{sd}	260	°C
Thermal resistance junction-to-ambient	EIA / JESD51	R _{thJA}	250	K/W

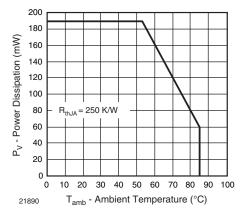


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

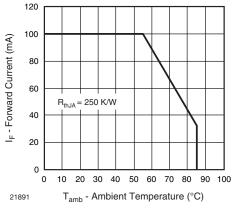


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
	I _F = 100 mA, t _p = 20 ms	V _F	-	1.6	1.9	V
Forward voltage	I _F = 1 A, t _p = 100 μs	V _F	-	2.8	-	V
Temperature coefficient of V _F	I _F = 100 mA	TK _{VF}	-	-1.5	-	mV/K
Reverse current		I _R	Not designed for reverse operation		μA	
Junction capacitance	$V_R = 0 V$, f = 1 MHz, E = 0 mW/cm ²	CJ	-	50	-	pF
Dedient intereit.	I _F = 100 mA, t _p = 20 ms	le	27	50	75	mW/sr
Radiant intensity	I _F = 1 A, t _p = 100 μs	l _e	-	350	-	mW/sr
Radiant power	I _F = 100 mA, t _p = 20 ms	фе	-	55	-	mW
Temperature coefficient of radiant power	I _F = 100 mA	TKφ _e	-	-0.12	-	%/K
Angle of half intensity		φ	-	± 28	-	deg
Peak wavelength	I _F = 100 mA	λ _p	840	850	870	nm
Spectral bandwidth	I _F = 100 mA	Δλ	-	30	-	nm
Temperature coefficient of λ_p	I _F = 100 mA	ΤΚλ _p	-	0.25	-	nm/K
Rise time	I _F = 100 mA, 10 % to 90 %	t _r	-	10	-	ns
Fall time	I _F = 100 mA, 10 % to 90 %	t _f	-	10	-	ns

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

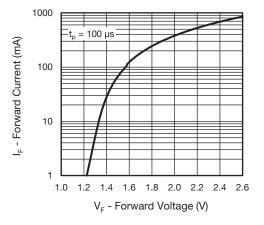


Fig. 3 - Forward Current vs. Forward Voltage

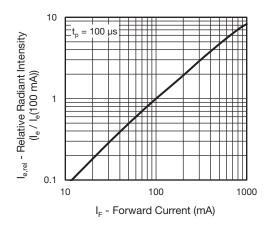


Fig. 4 - Relative Radiant vs. Forward Current

SOLDER PROFILE

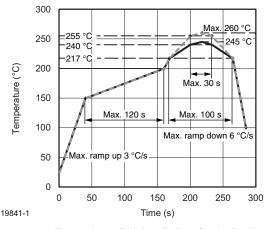


Fig. 7 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

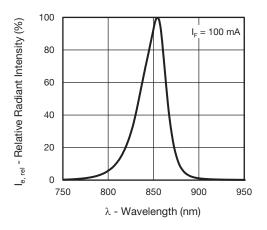


Fig. 5 - Relative Radiant Power vs. Wavelength

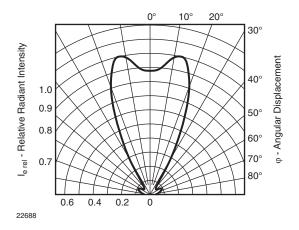


Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label: Floor life: 4 weeks Conditions: $T_{amb} < 30$ °C, RH < 60 % Moisture sensitivity level 2a, according to J-STD-020.

DRYING

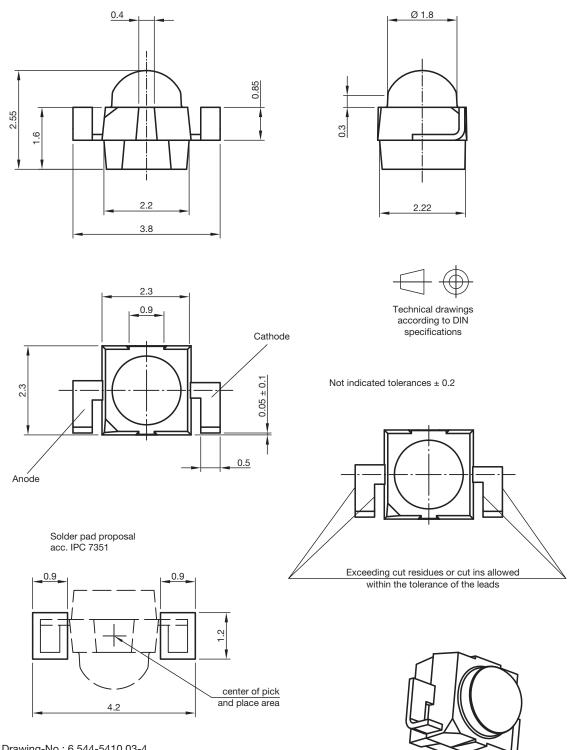
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

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PACKAGE DIMENSIONS in millimeters: VSMY2853SLX01



Rev. 1.0, 31-Jul-2018

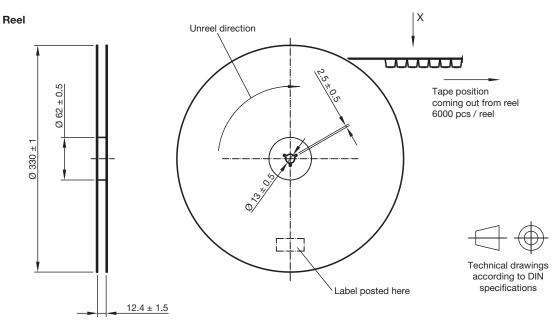
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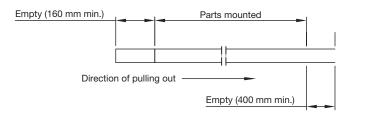


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Leader and trailer tape

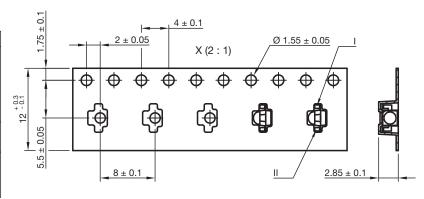
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Terminal position in tape

Device	Lead I	Lead II	
VSMB2943SLX01			
VSMF2893SLX01			
VSMB2948SL	Cathode	Anode	
VEMD2023SLX01			
VEMD2523SLX01	1		
VEMT2023SLX01	Collector	Emitter	
VEMT2523SLX01	Collector		
VSMY2853SL			
VSMY2943SL	Anode	Cathode	
VSMY294310SL	1		

Drawing-No.: 9.800-5123.01-4 Issue: 4; 02.10.15



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